

BRIGHT LED ELECTRONICS CORP.

SURFACE MOUNT CHIP LED LAMP SPECIFICATION

●COMMODITY : SURFACE MOUNT CHIP LED LAMP

●DEVICE NUMBER : BL-HH033

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●ELECTRICAL AND OPTICAL CHARACTERISTICS (Ta=25°C)

REVISION: 2.0

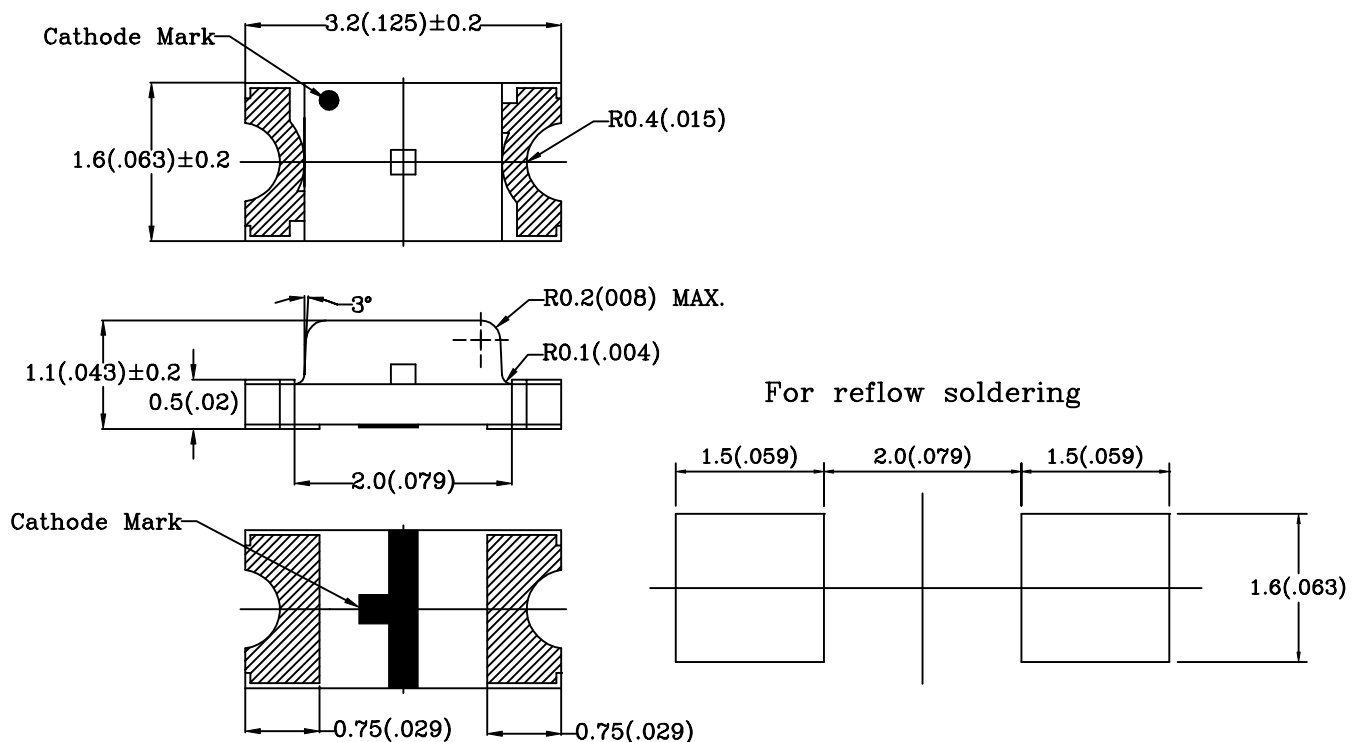
Chip			Lens Appearance	Absolute Maximum Rating				Electro-optical Data (At 20mA)				Viewing Angle 2 θ 1/2 (deg)
Emitted Color	Peak Wave Length λ p(nm)	Dominant Wave Length λ d(nm)		Δ λ (nm)	Pd (mW)	If (mA)	Peak If(mA)	Vf(V)		Iv(mcd)		
								Typ.	Max.	Min	Typ.	
Bright Red	700	650±5	Water Clear	100	40	15	50	2.3	2.6	0.3	0.8	120

Remark : Viewing angle is the Off-axis angle at which the luminous intensity is half the axial luminous intensity.

●ABSOLUTE MAXIMUM RATINGS (Ta=25°C)

Reverse Voltage	5V
Reverse Current (V _R =5V)	≤100μA
Operating Temperature Range	-25°C ~ 80°C
Storage Temperature Range	-30°C ~ 85°C

●PACKAGE DIMENSIONS



NOTES: 1.All dimensions are in millimeters (inches).

2.Tolerance is ± 0.10 mm (0.004) unless otherwise specified.

3.Specifications are subject to change without notice.

4.Condition for IFp is pulse of 1/10 duty and 0.1msec width.

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Fig.1 RELATIVE INTENSITY VS. WAVELENGTH

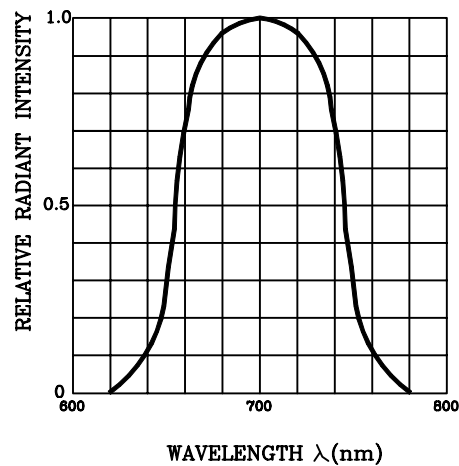


Fig.2 FORWARD CURRENT DERATING CURVE

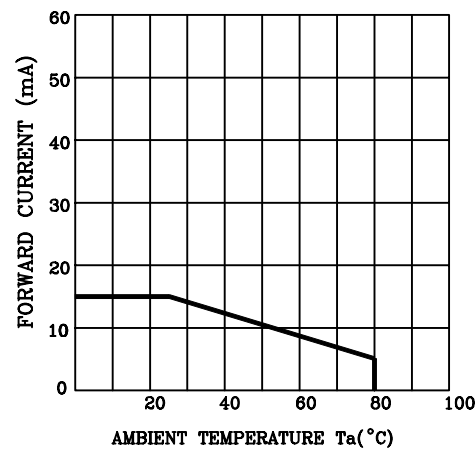


Fig.3 FORWARD CURRENT VS. FORWARD VOLTAGE

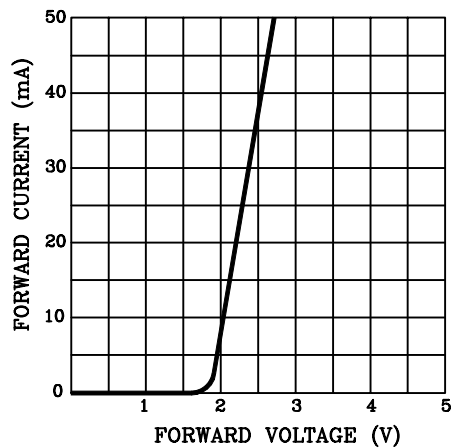


Fig.4 RELATIVE LUMINOUS INTENSITY VS. AMBIENT TEMPERATURE

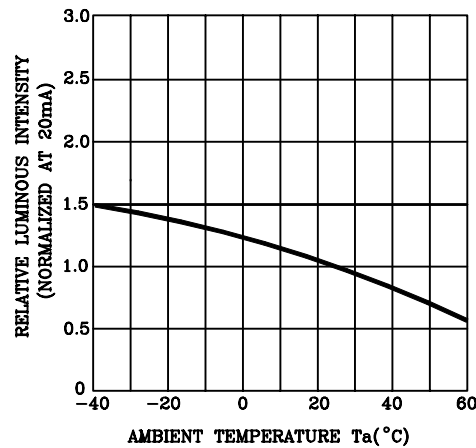


Fig.5 RELATIVE LUMINOUS INTENSITY VS. FORWARD CURRENT

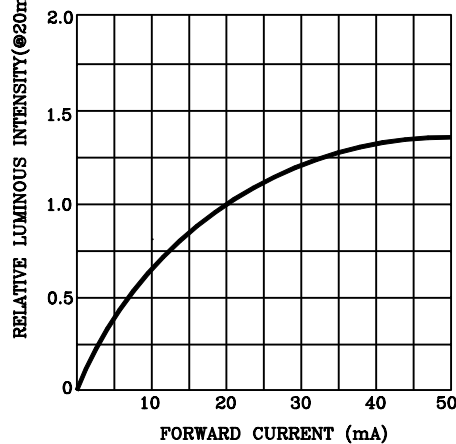
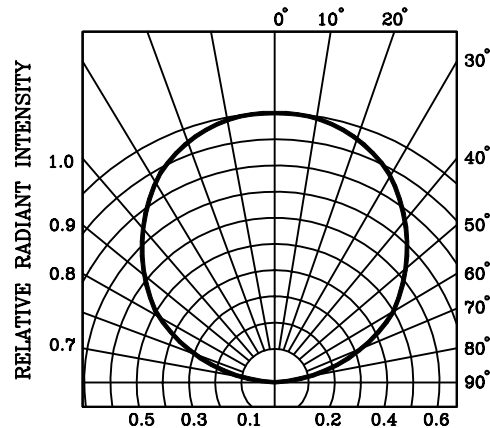


Fig.6 RADIATION DIAGRAM

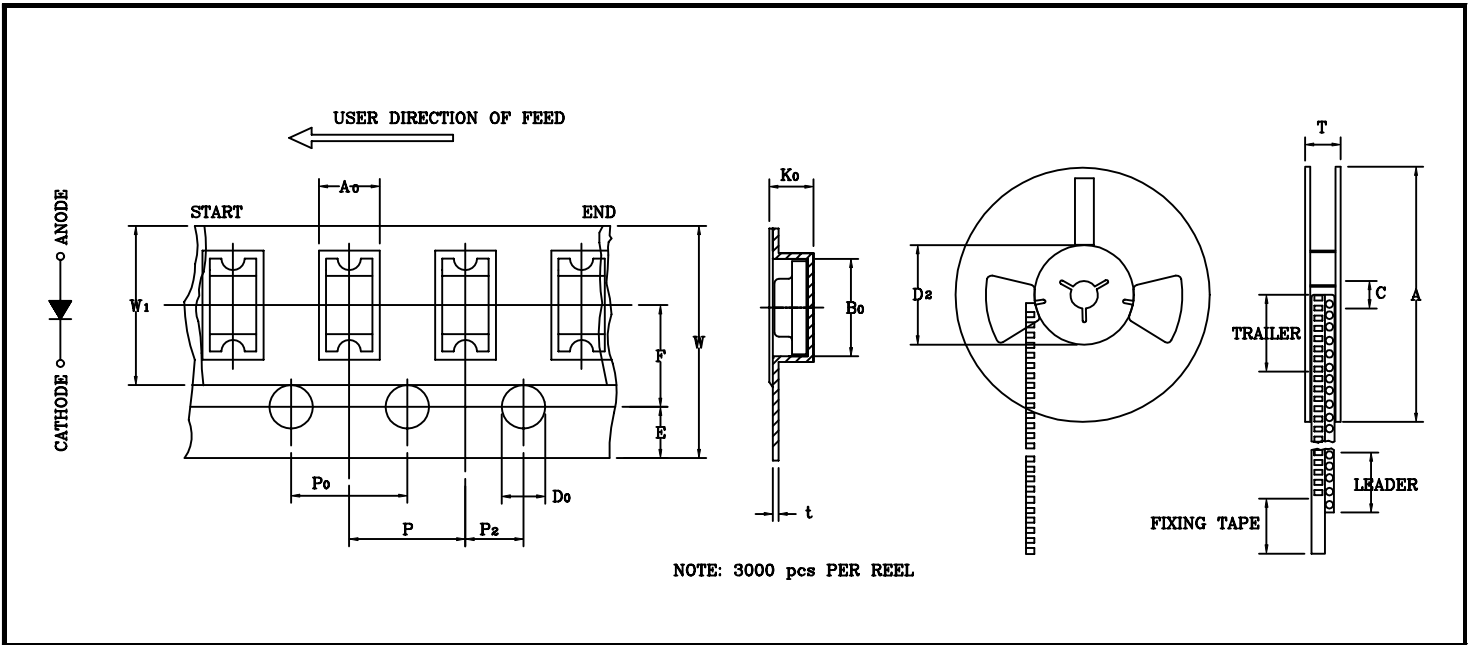


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SURFACE MOUNT CHIP LED LAMP SPECIFICATION

- COMMODITY : SURFACE MOUNT CHIP LED LAMP
- DEVICE NUMBER : BL-HH033-TRB
- TRB: TAPPING & REELING, BLACK CAMRIER TAPE, ESD RESISTED.
- TAPPING AND PACKAGING SPECIFICATION
- PAGE: 4
- REVISION: 1.3

ITEM	SYMBOL	SPECIFICATION			
		Minimum		Maximum	
		mm	inch	mm	inch
Tape Feed Hole Diameter (DIA)	D ₀	1.40	0.055	1.60	0.063
Feed Hole Location	E	1.65	0.064	1.85	0.073
Centers Line Dimensions Length Direction	F	3.45	0.135	3.55	0.139
Compartment Depth	K ₀	1.17	0.046	1.37	0.054
Compartment Pitch	P	3.90	0.153	4.10	0.161
Sprocket Hole Diameter	P ₀	3.90	0.153	4.10	0.161
Centers Line Dimensions Length Direction	P ₂	1.95	0.076	2.05	0.080
Carrier Tape Thickness	t	—	—	0.30	0.012
Carrier Tape Width	W	7.70	0.303	8.30	0.326
Flange Diameter	A	178.0	7.008	180.0	7.087
Hub Spindle Hole	C	12.50	0.492	13.50	0.531
Hub Diameter	D ₂	70.00	2.755	72.00	2.830
Fixing Tape Width	W ₁	5.25	0.206	5.35	0.210
Flange Space Between Flanges	T	12.50	0.492	13.50	0.531
Compartment Length	A ₀	1.78	0.070	1.98	0.078
Compartment Width	B ₀	3.40	0.134	3.60	0.142



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RELIABILITY TEST

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Classification	Test Item	Reference Standard	Test Conditions	Result
Endurance Test	Operation Life	MIL-STD-750:1026 MIL-STD-883:1005 JIS C 7021 :B-1	Connect with a power $I_f=20\text{mA}$ T_a =Under room temperature Test time=1,000hrs	0/20
	High Temperature High Humidity Storage	MIL-STD-202:103B JIS C 7021 :B-11	$T_a=+65^{\circ}\text{C}\pm 5^{\circ}\text{C}$ RH=90%-95% Test time=240hrs	0/20
	High Temperature Storage	MIL-STD-883:1008 JIS C 7021 :B-10	High $T_a=+85^{\circ}\text{C}\pm 5^{\circ}\text{C}$ Test time=1,000hrs	0/20
	Low Temperature Storage	JIS-C-7021 :B-12	Low $T_a=-35^{\circ}\text{C}\pm 5^{\circ}\text{C}$ Test time=1,000hrs	0/20
Environmental Test	Temperature Cycling	MIL-STD-202:107D MIL-STD-750:1051 MIL-STD-883:1010 JIS C 7021 :A-4	$-35^{\circ}\text{C} \sim +25^{\circ}\text{C} \sim +85^{\circ}\text{C} \sim +25^{\circ}\text{C}$ 60min 20min 60min 20min Test Time=5cycle	0/20
	Thermal Shock	MIL-STD-202:107D MIL-STD-750:1051 MIL-STD-883:1011	$-35^{\circ}\text{C}\pm 5^{\circ}\text{C} \sim +85^{\circ}\text{C}\pm 5^{\circ}\text{C}$ 20min 20min Test Time=10cycle	0/20
	Solder Resistance	MIL-STD-202:201A MIL-STD-750:2031 JIS C 7021 :A-1	Preheating : 140°C -160°C ,within 2 minutes. Operation heating : 235°C (Max.), within 10seconds. (Max.)	0/20

JUDGMENT CRITERIA OF FAILURE FOR THE RELIABILITY

Measuring items	Symbol	Measuring conditions	Judgement criteria for failure
Forward voltage	V_F (V)	$I_f=20\text{mA}$	Over $U \times 1.2$
Reverse current	$I_r(\mu\text{A})$	$V_r=5\text{V}$	Over $U \times 2$
Luminous intensity	I_v (mcd)	$I_f=20\text{mA}$	Below $S \times 0.5$

Note: 1.U means the upper limit of specified characteristics. S means initial value.

2.Measurment shall be taken between 2 hours and after the test pieces have been returned to normal ambient conditions after completion of each test.